

# SMALL SIGNAL NPN TRANSISTOR

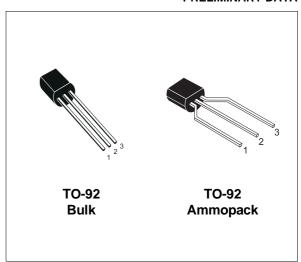
#### **PRELIMINARY DATA**

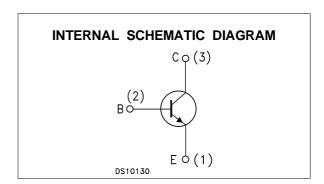
Ordering Code	Marking	Package / Shipment
2N3904	2N3904	TO-92 / Bulk
2N3904-AP	2N3904	TO-92 / Ammopack

- SILICON EPITAXIAL PLANAR NPN TRANSISTOR
- TO-92 PACKAGE SUITABLE FOR THROUGH-HOLE PCB ASSEMBLY
- THE PNP COMPLEMENTARY TYPE IS 2N3906

### **APPLICATIONS**

- WELL SUITABLE FOR TV AND HOME APPLIANCE EQUIPMENT
- SMALL LOAD SWITCH TRANSISTOR WITH HIGH GAIN AND LOW SATURATION VOLTAGE





### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CBO}$	Collector-Base Voltage (I <sub>E</sub> = 0)	60	V
$V_{CEO}$	Collector-Emitter Voltage (I <sub>B</sub> = 0)	40	V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	6	V
Ic	Collector Current	200	mA
P <sub>tot</sub>	Total Dissipation at T <sub>C</sub> = 25 °C	625	mW
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

February 2003 1/5

### THERMAL DATA

R <sub>thj-amb</sub> •	Thermal Resistance Junction-Ambient	Max	200	°C/W
R <sub>thj-case</sub> •	Thermal Resistance Junction-Case	Max	83.3	°C/W

# **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25$ $^{\circ}C$ unless otherwise specified)

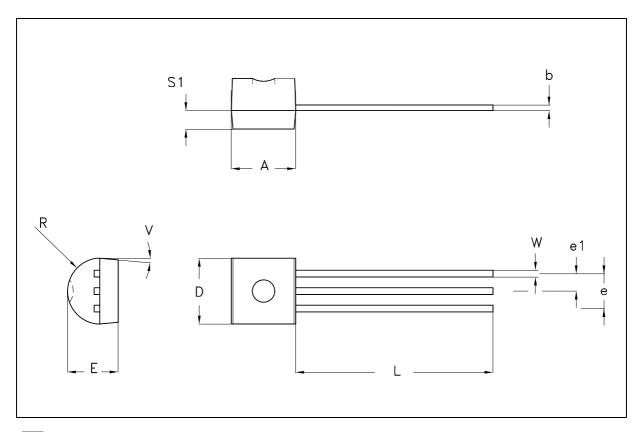
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CEX</sub>	Collector Cut-off Current (V <sub>BE</sub> = -3 V)	V <sub>CE</sub> = 30 V			50	nA
I <sub>BEX</sub>	Base Cut-off Current (V <sub>BE</sub> = -3 V)	V <sub>CE</sub> = 30 V			50	nA
V <sub>(BR)CEO*</sub>	Collector-Emitter Breakdown Voltage (I <sub>B</sub> = 0)	Ic = 1 mA	40			V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage (I <sub>E</sub> = 0)	I <sub>C</sub> = 10 μA	60			V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage (I <sub>C</sub> = 0)	Ι <sub>Ε</sub> = 10 μΑ	6			V
V <sub>CE(sat)*</sub>	Collector-Emitter Saturation Voltage	$\begin{split} I_C &= 10 \text{ mA} & I_B = 1 \text{ mA} \\ I_C &= 50 \text{ mA} & I_B = 5 \text{ mA} \end{split}$			0.2 0.2	V V
V <sub>BE(sat)*</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 10 mA	0.65		0.85 0.95	V V
h <sub>FE</sub> *	DC Current Gain	I <sub>C</sub> = 0.1 mA	60 80 100 60 30		300	
f <sub>T</sub>	Transition Frequency	$I_C = 10 \text{ mA} \ V_{CE} = 20 \text{ V} \ \text{f} = 100 \text{ MHz}$	250	270		MHz
Ссво	Collector-Base Capacitance	I <sub>E</sub> = 0 V <sub>CB</sub> = 10 V f = 1 MHz		4		pF
СЕВО	Emitter-Base Capacitance	I <sub>C</sub> = 0 V <sub>EB</sub> = 0.5 V f = 1 MHz		18		pF
NF	Noise Figure	$V_{CE}$ = 5 $V$ $I_{C}$ = 0.1 mA $f$ = 10 Hz to 15.7 KHz $R_{G}$ = 1 $K\Omega$		5		dB
t <sub>d</sub> t <sub>r</sub>	Delay Time Rise Time	$I_C = 10 \text{ mA}$ $I_B = 1 \text{ mA}$ $V_{CC} = 30 \text{ V}$			35 35	ns ns
t <sub>s</sub>	Storage Time Fall Time	$I_{C} = 10 \text{ mA}$ $I_{B1} = -I_{B2} = 1 \text{ mA}$ $V_{CC} = 30 \text{ V}$			200 50	ns ns

<sup>\*</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle  $\leq$  2 %

2/5

## **TO-92 MECHANICAL DATA**

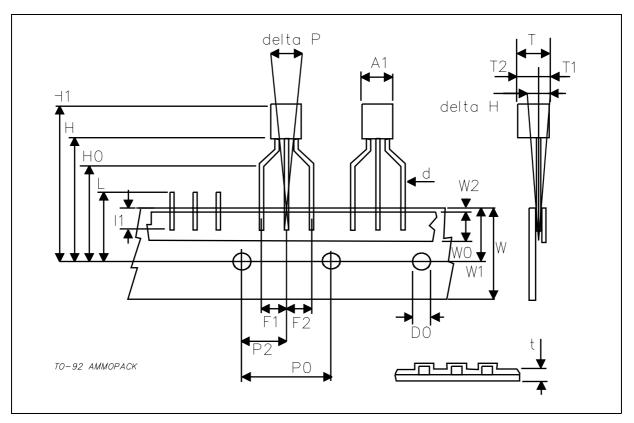
DIM.	mm			inch			
2	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.32		4.95	0.170		0.195	
b	0.36		0.51	0.014		0.020	
D	4.45		4.95	0.175		0.194	
Е	3.30		3.94	0.130		0.155	
е	2.41		2.67	0.095		0.105	
e1	1.14		1.40	0.045		0.055	
L	12.70		15.49	0.500		0.609	
R	2.16		2.41	0.085		0.094	
S1	1.14		1.52	0.045		0.059	
W	0.41		0.56	0.016		0.022	
V	4 degree		6 degree	4 degree		6 degree	



47/

# TO-92 AMMOPACK SHIPMENT (Suffix"-AP") MECHANICAL DATA

DIM.	mm			inch			
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
A1			4.80			0.189	
T			3.80			0.150	
T1			1.60			0.063	
T2			2.30			0.091	
d			0.48			0.019	
P0	12.50	12.70	12.90	0.492	0.500	0.508	
P2	5.65	6.35	7.05	0.222	0.250	0.278	
F1,F2	2.44	2.54	2.94	0.096	0.100	0.116	
delta H	-2.00		2.00	-0.079		0.079	
W	17.50	18.00	19.00	0.689	0.709	0.748	
W0	5.70	6.00	6.30	0.224	0.236	0.248	
W1	8.50	9.00	9.25	0.335	0.354	0.364	
W2			0.50			0.020	
Н	18.50		20.50	0.728		0.807	
H0	15.50	16.00	16.50	0.610	0.630	0.650	
H1			25.00			0.984	
D0	3.80	4.00	4.20	0.150	0.157	0.165	
t			0.90			0.035	
L			11.00			0.433	
l1	3.00			0.118			
delta P	-1.00		1.00	-0.039		0.039	



4/5

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specification mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a trademark of STMicroelectronics

© 2003 STMicroelectronics – Printed in Italy – All Rights Reserved STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States.

http://www.st.com

